4-Bit Dual-Supply Non-Inverting Level Translator

The NLSV4T244E is a 4-bit configurable dual-supply voltage level translator. The input An and output Bn ports are designed to track two different power supply rails, V_{CCA} and V_{CCB} respectively. Both supply rails are configurable from 0.9 V to 4.5 V allowing universal low-voltage translation from the input A_n to the output B_n port.

Features

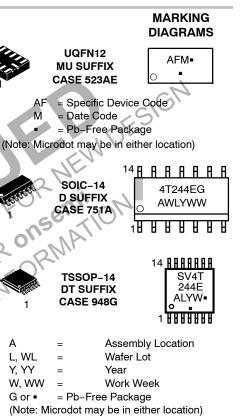
- Wide V_{CCA} and V_{CCB} Operating Range: 0.9 V to 4.5 V
- High-Speed w/ Balanced Propagation Delay
- Inputs and Outputs have OVT Protection to 4.5 V
- Non-preferential V_{CCA} and V_{CCB} Sequencing
- Outputs at 3-State until Active V_{CC} is Reached
- Power-Off Protection
- Outputs Switch to 3-State with V_{CCB} at GND
- Data Rate > 200 Mbps @ $V_{CCA} = 1.8 V$, $V_{CCB} = 3.3 V$, $R_L = 2 k$

- - HBM (Human Body Model) > 2000 V MM (Machine Model) > 400 V THISDE



ON Semiconductor®

www.onsemi.com



JUR ONS'

I WI

Y, YY

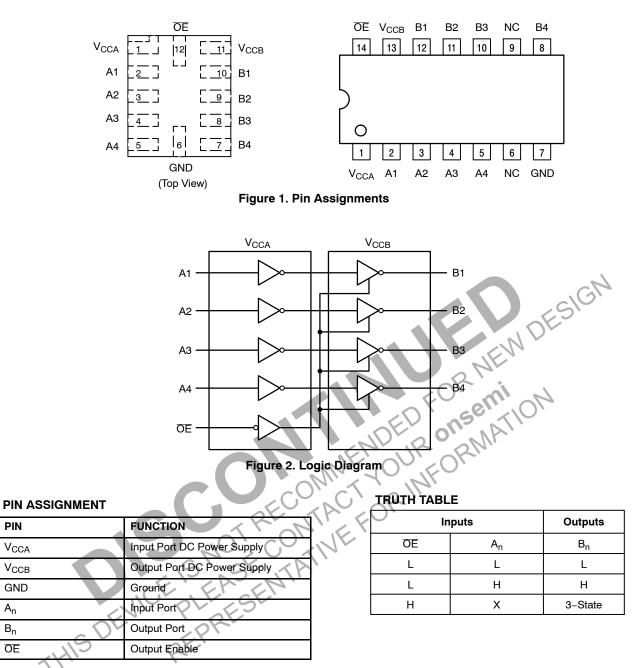
W. WW

G or •

ATIVEFOR

ORDERING INFORMATION									
Device	Package	Shipping [†]							
NLSV4T244EMUTAG	UQFN12 (Pb-Free)	3000/Tape & Reel							
NLSV4T244EDR2G	SO-14 (Pb-Free)	2500/Tape & Reel							
NLSV4T244EDTR2G	TSSOP14 (Pb-Free)	2500/Tape & Reel							

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.



MAXIMUM RATINGS

Symbol	Rating		Condition	Value	Unit
V_{CCA}, V_{CCB}	DC Supply Voltage			-0.5 to +5.5	V
VI	DC Input Voltage	A _n		–0.5 to +5.5	V
V _C	Control Input	ŌĒ		–0.5 to +5.5	V
Vo	DC Output Voltage (Power Down)	Bn	$V_{CCA} = V_{CCB} = 0$	-0.5 to +5.5	V
	(Active Mode)	Bn		–0.5 to +5.5	V
	(Tri-State Mode)	Bn		–0.5 to +5.5	V
I _{IK}	DC Input Diode Current		V _I < GND	-20	mA
I _{OK}	DC Output Diode Current		V _O < GND	-50	mA
Ι _Ο	DC Output Source/Sink Current			±50	mA
I _{CCA} , I _{CCB}	DC Supply Current Per Supply Pin			±100	mA
I _{GND}	DC Ground Current per Ground Pin			±100	mA
T _{STG}	Storage Temperature Range			-65 to +150	°C
TJ	Junction Temperature			+125	°C
θ_{JA}	Junction-to-Ambient Thermal Resistance			53	°C/W
$\Psi_{\text{JC(top)}}$	Junction-to-Case (Top) Thermal Resistance			10	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. ED FORSemilon

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Мах	Unit
V_{CCA}, V_{CCB}	Positive DC Supply Voltage	0.9	4.5	V
VI	Bus Input Voltage	GND	4.5	V
V _C	Control Input OE	GND	4.5	V
V _{IO}	Bus Output Voltage (Power Down Mode) B _n	GND	4.5	V
	(Active Mode) B _n	GND	V _{CCB}	V
	S S Ari-State Mode) B _n	GND	4.5	V
T _A	Operating Temperature Range	-40	+85	°C
$\Delta t / \Delta V$	Input Transition Rise or Rate V _I , from 30% to 70% of V _{CC} ; V _{CC} = 3.3 V \pm 0.3 V	0	10	nS

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

					-40°C to	o +85°C	
Symbol	Parameter	Test Conditions	V _{CCA} (V)	V _{CCB} (V)	Min	Max	Uni
V _{IH}	Input HIGH Voltage		3.6 – 4.5	0.9 - 4.5	2.2	-	V
	(An, OE)		2.7 – 3.6		2.0	-	1
			2.3 – 2.7		1.6	-	1
			1.4 – 2.3		0.65 * V _{CCA}	-	
			0.9 – 1.4		0.9 * V _{CCA}	-	
V _{IL}	Input LOW Voltage		3.6 – 4.5	0.9 - 4.5	-	0.8	V
	(An, OE)		2.7 – 3.6		-	0.8	
			2.3 – 2.7		-	0.7	
			1.4 – 2.3		-	0.35 * V _{CCA}	
			0.9 – 1.4		_	0.1 * V _{CCA}	
V _{OH}	Output HIGH Voltage	I_{OH} = -100 μ A; V _I = V _{IH}	0.9 – 4.5	0.9 - 4.5	V _{CCB} - 0.2	-	V
		$I_{OH} = -0.5 \text{ mA}; V_I = V_{IH}$	0.9	0.9	0.75 * V _{CCB}	10	
		$I_{OH} = -2 \text{ mA}; V_I = V_{IH}$	1.4	1.4	1.05	SF	
		$I_{OH} = -6 \text{ mA}; V_I = V_{IH}$	1.65	1.65	1.25	-	
			2.3	2.3	2.0	-	
		$I_{OH} = -12 \text{ mA}; V_I = V_{IH}$	2.3	2.3	1.8	-	
			2.7	2.7	2.2	-	
		$I_{OH} = -18 \text{ mA}; \text{ V}_{I} = \text{V}_{IH}$	2.3	2.3	1.7	-	
			3.0	3.0	2.4	-	
		$I_{OH} = -24 \text{ mA}; V_I = V_{IH}$	3.0	3.0	2.2	-	
V _{OL}	Output LOW Voltage	I _{OL} = 100 μA; V _I = V _{IL}	0.9 – 4.5	0.9 – 4.5	-	0.2	V
		$I_{OL} = 0.5 \text{ mA}; V_{I} = V_{IH}$			-	0.3	
		$I_{OL} = 2 \text{ mA}; V_I = V_{IH}$	1.4	1.4	-	0.35	
		$I_{OL} = 6 \text{ mA}; V_I = V_{IL}$	1.65	1.65	-	0.3	
		I _{OL} = 12 mA; V _I = V _{IL}	2.3	2.3	-	0.4	
			2.7	2.7	-	0.4	
	DUCE IS NO	I _{OL} = 18 mA; V _I = V _{IL}	2.3	2.3	-	0.6	
	CE EP		3.0	3.0	-	0.45	
		$I_{OL} = 24 \text{ mA}; V_I = V_{IL}$	3.0	3.0	-	0.6	
կ	Input Leakage Current	$V_1 = V_{CCA}$ or GND	0.9 – 4.5	0.9 – 4.5	-1.0	1.0	μA
I _{OFF}	Power-Off Leakage Current	<u>OE</u> = 0 V	0 0.9 – 4.5	0.9 – 4.5 0	-1.0 -1.0	1.0 1.0	μA
ICCA	Quiescent Supply Current	$V_{I} = V_{CCA}$ or GND; $I_{O} = 0$, $V_{CCA} = V_{CCB}$	0.9 - 4.5	0.9 – 4.5	-	2.0	μA
I _{CCB}	Quiescent Supply Current		0.9 – 4.5	0.9 – 4.5	-	2.0	μA
CCA + I _{CCB}	Quiescent Supply Current		0.9 – 4.5	0.9 – 4.5	-	4.0	μΑ
ΔI_{CCA}	Increase in I_{CC} per Input Voltage, Other Inputs at V_{CCA} or GND	$V_{I} = V_{CCA} - 0.6 V;$ $V_{I} = V_{CCA}$ or GND	4.5 3.6	4.5 3.6	-	10 5.0	μA
ΔI_{CCB}	Increase in I_{CC} per Input Voltage, Other Inputs at V_{CCA} or GND	$V_{I} = V_{CCA} - 0.6 V;$ $V_{I} = V_{CCA}$ or GND	4.5 3.6	4.5 3.6	-	10 5.0	μΑ
I _{OZ}	I/O Tri-State Output Leakage Current	$ T_A = 25^{\circ} C, \ \overline{OE} = 0 V_{CCA}, \\ V_O = 0 \ \text{to} \ V_{CCB} + 0.5 \ V $	0.9 – 4.5	0.9 – 4.5	_	1.0	μA
		$T_A = 25^{\circ}C, \overline{OE} = 0V_{CCA},$ $V_O = 0 \text{ to } 4.5 \text{ V}$			-	75	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TOTAL STATIC POWER CONSUMPTION (I_{CCA} + I_{CCB})

	-40°C to +85°C										
					Vcc	_в (V)					
	4	4.5 3.3 2.8 1.8 0.9						.9			
V _{CCA} (V)	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Unit
4.5		2		2		2		2		< 1.5	μA
3.3		2		2		2		2		< 1.5	μA
2.8		< 2		< 1		< 1		< 0.5		< 0.5	μΑ
1.8		< 1		< 1		< 0.5		< 0.5		< 0.5	μΑ
0.9		< 0.5		< 0.5		< 0.5		< 0.5		< 0.5	μA

NOTE: Connect ground before applying supply voltage V_{CCA} or V_{CCB}. This device is designed with the feature that the power-up sequence of V_{CCA} and V_{CCB} will not damage the IC.

AC ELECTRICAL CHARACTERISTICS

			-40°C to +85°C										
							V _{CCI}	∃ (V)			0	JG	•
			4.	.5	3.	.3	2.	.8	1	.8		.5	
Symbol	Parameter	V _{CCA} (V)	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Unit
t _{PLH} ,	Propagation	4.5		3.0		3.2		3.4		3.7		4.0	nS
t _{PHL} (Note 1)	Delay,	3.6		3.3		3.5		3.7	2	4.0		4.3	
	A _n to B _n	2.8		3.5		3.7		3.9)	4.2	1	4.5	
		1.8		3.8		4.0		4.2	SU	4.5))	4.8	
		1.5		4.1		4.3		4.5	1 . 1	4.8		5.0	
t _{PZH} ,	Output	4.5		4.4		4.8		5.2	217	5.7		6.2	nS
t _{PZL} (Note 1)	Enable,	3.3		4.7		5.1	5	5.5		6.0		6.5	
(14010-1)	OE to B _n	2.8		4.9	O''	5.3	0	5.7		6.2		6.7	
		1.8		5.2	12.	5.6	O_{L}	6.0		6.5		7.0	
		1.5	~	5.5	1.	5,9		6.3		6.8		7.3	
t _{PHZ} ,	Output	4.5	<u>10</u>	4.4	く	4.8		5.2		5.7		6.2	nS
t _{PLZ} (Note 1)	Disable,	3.3	Ś	4.7	A)	5.1		5.5		6.0		6.5	
(14010-1)	\overline{OE} to B_n	2.8		4.9	*	5.3		5.7		6.2		6.7	
		1.8		5.2		5.6		6.0		6.5		7.0	
	DE.	1.5	Kr	5.5		5.9		6.3		6.8		7.3	
t _{OSHL} ,	Output to	4.1		0.15		0.15		0.15		0.15		0.15	nS
t _{OSLH} (Note 1)	Output Skew, Data to Out-	3.6		0.15		0.15		0.15		0.15		0.15	
	put	2.8		0.15		0.15		0.15		0.15		0.15	
		1.8		0.15		0.15		0.15		0.15		0.15	
		1.2		0.15		0.15		0.15		0.15		0.15	

1. Propagation delays defined per Figures 3 and 4.

CAPACITANCE

Symbol	Parameter	Test Conditions	Typ (Note 2)	Unit
C _{IN}	Control Pin Input Capacitance	V_{CCA} = V_{CCB} = 3.3 V, V_{I} = 0 V or $V_{CCA/B}$	3.5	pF
C _{I/O}	I/O Pin Input Capacitance	V_{CCA} = V_{CCB} = 3.3 V, V_{I} = 0 V or $V_{CCA/B}$	5.0	pF
C _{PD}	Power Dissipation Capacitance	V_{CCA} = V_{CCB} = 3.3 V, V_{I} = 0 V or V_{CCA},f = 10 MHz	20	pF

2. Typical values are at $T_A = +25^{\circ}$ C. 3. C_{PD} is defined as the value of the IC's equivalent capacitance from which the operating current can be calculated from: $I_{CC(operating)} \cong C_{PD} \times V_{CC} \times f_{IN} \times N_{SW}$ where $I_{CC} = I_{CCA} + I_{CCB}$ and N_{SW} = total number of outputs switching.

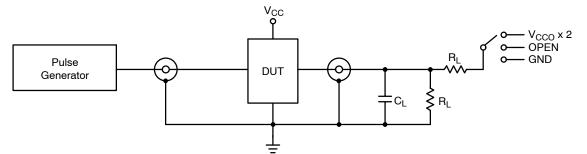
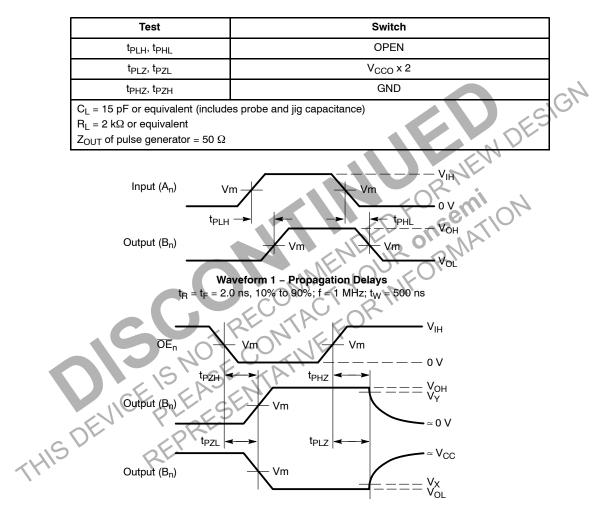


Figure 3. AC (Propagation Delay) Test Circuit



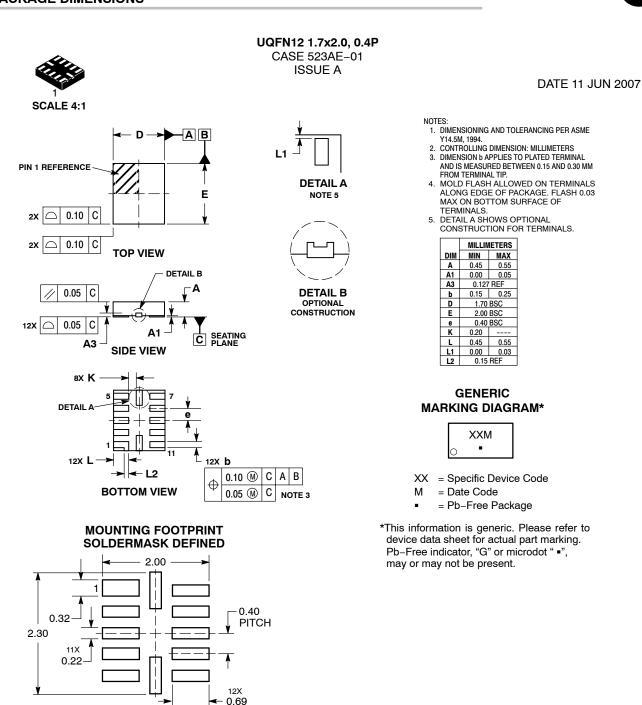
Waveform 2 – Output Enable and Disable Times $t_{B} = t_{F} = 2.0 \text{ ns}, 10\% \text{ to } 90\%; f = 1 \text{ MHz}; t_{W} = 500 \text{ ns}$

Figure 4. AC (Propagation Delay)	Test Circuit Waveforms
----------------------------------	------------------------

	V _{CC}								
Symbol	3.0 V – 4.5 V	2.3 V – 2.7 V	1.65 V – 1.95 V	1.4 V – 1.6 V	0.9 V – 1.3 V				
V _{mA}	V _{CCA} /2								
V _{mB}	V _{CCB} /2								
V _X	V _{OL} x 0.1								
V _Y	V _{OH} x 0.9								

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





DOCUMENT NUMBER:	98AON23418D	Electronic versions are uncontrolled except when accessed directly from the Document Reposite Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.					
DESCRIPTION:	UQFN12 1.7 X 2.0, 0.4P		PAGE 1 OF 1				
ON Semiconductor reserves the right the suitability of its products for any pa	to make changes without further notice to an articular purpose, nor does ON Semiconducto	stries, LLC dba ON Semiconductor or its subsidiaries in the United States y products herein. ON Semiconductor makes no warranty, representation r assume any liability arising out of the application or use of any product o icidental damages. ON Semiconductor does not convey any license under	or guarantee regarding r circuit, and specifically				

DIMENSIONS: MILLIMETERS

© Semiconductor Components Industries, LLC, 2019

rights of others.

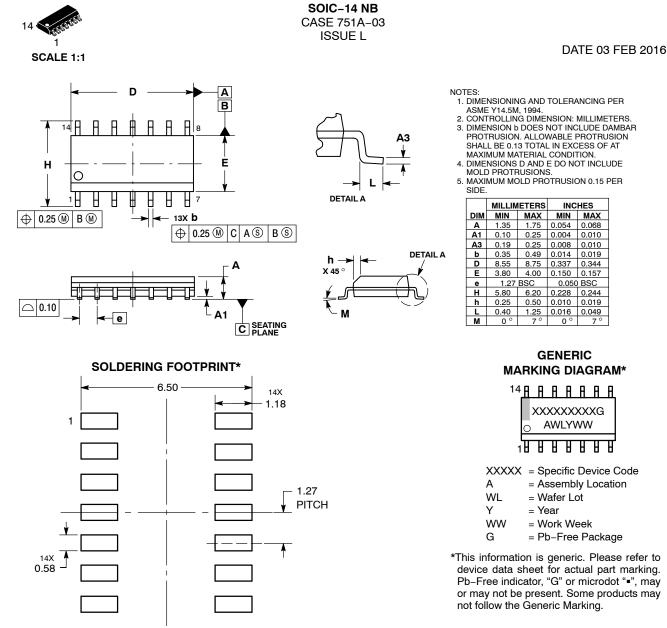
DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98ASB42565B Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOIC-14 NB PAGE 1 OF 2 onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

SOIC-14 CASE 751A-03 ISSUE L

DATE 03 FEB 2016

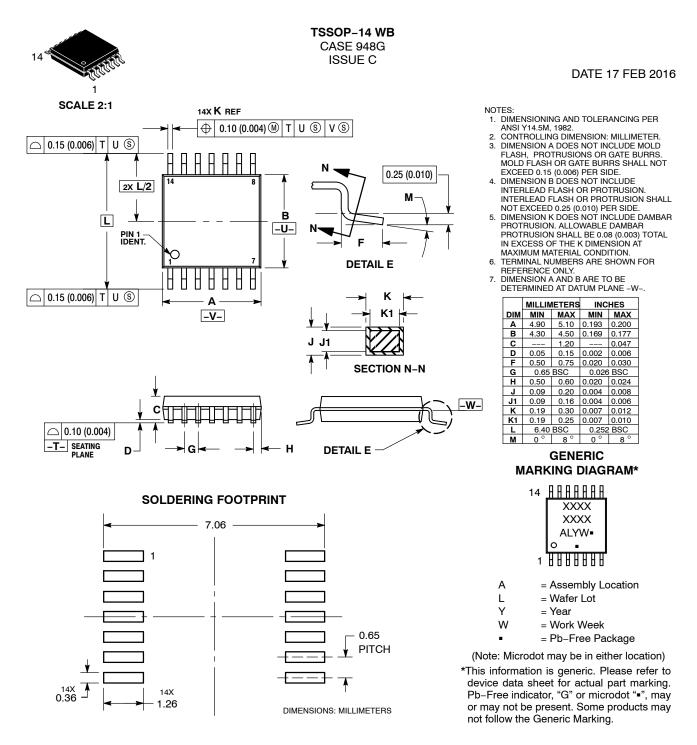
STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

DOCUMENT NUMBER:	98ASB42565B	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.					
DESCRIPTION:	SOIC-14 NB	PAGE 2					

onsemi and ONSEMI: are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

onsemi



DOCUMENT NUMBER:	98ASH70246A	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	TSSOP-14 WB		PAGE 1 OF 1
onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular			

purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation

special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

© Semiconductor Components Industries, LLC, 2019

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>